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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Applicant Patricia B. Smith, et al. Docket Number: TI-29811

Serial No.: 09/975,639 Art Unit: 2818

Filed: 10/11/01 Examiner: Quoc D. Hoang

For: Hydrogen Plasma Photoresist Strip and Polymeric Residue
Cleanup Process for Low Dielectric Constant Materials

CERTIFICATION OF FACSIMILE TRANSMISSION

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Karen Vertz
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12-23-04
Date

FACSIMILE COVER SHEET

<input checked="" type="checkbox"/> FACSIMILE COVER SHEET	AMENDMENT _____ (# Pages) _____
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<input type="checkbox"/> CONTINUATION APPN	ELECTION
<input type="checkbox"/> DIVISIONAL APPN	
NAME OF INVENTOR(S):	
Patricia B. Smith, et al.	
RECEIPT DATE & SERIAL NO.:	
Serial No.: 09/975,639	
TITLE OF INVENTION: Hydrogen Plasma Photoresist Strip and Polymeric Residue Cleanup Process for Low Dielectric Constant Materials	
Filing Date: 10/11/01	
TI FILE NO.:	DEPOSIT ACCT. NO.:
TI-29811	20-0668
FAXED: 12-23-04	
DUE: 1-1-05	
ATTY/SECY: RAK/kjv	

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Texas Instruments Incorporated
PO Box 655474, M/S 3999
Dallas, TX 75265-6474

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Patricia B. Smith, et al.

Serial No.: 09/975,639

Filed: 10/11/01

For: Hydrogen Plasma Photoresist Strip and Polymeric Residue Cleanup Process for Low Dielectric Constant Materials

TI-29811

Examiner: Quoc D. Hoang

Art Unit: 2818

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NOTICE OF APPEAL FROM THE PRIMARY EXAMINER TO THE BOARD OF APPEALS

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Applicant hereby appeals claims 1, 5-13, 30-39 and 60-68 to the Board of Appeals from the decision dated October 1, 2004 of the Primary Examiner finally rejecting claims 1, 5-13, 30-39 and 60-68.

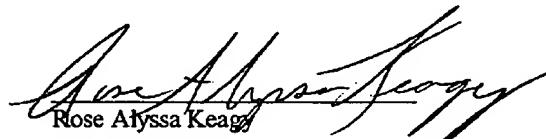
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Karen Vertz	12-23-04
Date	

The item(s) checked below are appropriate:

1. An extension of time to respond to the final rejection
 was granted on ____.
 is requested for ____ month(s).
2. A timely response to the final rejection has been filed, as provided in 841 O.G. 1411.
3. Fee \$500.00:
 Not required (Fee paid in prior appeal)
 The Commissioner of Patents is hereby authorized to charge any fees which may be required, or credit any overpayment to Deposit Account No. 20-0668 of Texas Instruments Incorporated.

Signature [Rule 191(b)]

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